

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
FENG LIANG	05/08/2023
ZHIPENG XIE	05/08/2023
DA ZHANG	05/08/2023
LONG MA	05/08/2023
YICHANG LIU	05/08/2023
JUNXI LI	05/08/2023
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State/Country:	CHINA
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	18315162
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DATE SIGNED:	05/11/2023
Total Attachments: 3	

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ASSIGNMENT

FENG LIANG having a mailing address NO. 68, WENCHANG ROAD, YIERYI STREET, KUNMING, CHINA

ZHIPENG XIE having a mailing address NO. 68, WENCHANG ROAD, YIERYI STREET, KUNMING, CHINA

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YICHANG LIU having a mailing address NO. 68, WENCHANG ROAD, YIERYI STREET, KUNMING, CHINA

JUNXI LI having a mailing address NO. 68, WENCHANG ROAD, YIERYI STREET, KUNMING, CHINA (hereafter referred to as the undersigned), are the inventors of the U.S. patent application to be filed entitled:

**CARBON NANOHORNS COMPOSITE MATERIAL WITH MICROWAVE
ABSORPTION AND TUNABLE ABSORPTION BANDS AND METHOD FOR
PREPARING THE SAME**

The above U.S. application was assigned serial no. _____ and was filed on _____. The undersigned hereby authorizes assignee or assignee's representative to insert the Application Number and the filing date of this application if they are unknown at the time of execution of this assignment.

KUNMING UNIVERSITY OF SCIENCE AND TECHNOLOGY Having a place of business NO. 68, WENCHANG ROAD, YIERYI STREET, KUNMING, CHINA (hereafter referred to as the assignee), is desirous of the entire right, title and interest in the above-identified application, in said invention described therein, all applications for and all letters patent issued on said invention.

For good and valuable consideration, the receipt and sufficiency of which is acknowledged, the undersigned, intending to be legally bound, does hereby sell, assign and transfer to the assignee

and assignee's successors, assigns and legal representatives the entire right, title and interest in said invention and all patent applications thereon, including, but not limited to, the application for United States Letters Patent entitled as above, in any subsequent nonprovisional applications filed for this invention or improvements thereto, and all divisions and continuations thereof, any Registered Community Design applications, and in all letters patent, including all reissues and reexaminations thereof, throughout the world, including the right to claim priority under the Paris Convention or other treaty.

It is agreed that the undersigned shall be legally bound, upon request of the assignee, to supply all information and evidence relating to the making and practice of said invention, to testify in any legal proceeding relating thereto, to execute all instruments proper to patent the invention throughout the world for the benefit of the assignee, and to execute all instruments proper to carry out the intent of this instrument.

The undersigned warrant that the rights and property herein conveyed are free and clear of any encumbrance. EXECUTED under seal on the following date 05/08/2023

Typed or printed name	Signature
<u>FENG LIANG</u>	<u>/FENG LIANG/</u>
<u>ZHIPENG XIE</u>	<u>/ZHIPENG XIE/</u>
<u>DA ZHANG</u>	<u>/DA ZHANG/</u>
<u>LONG MA</u>	<u>/LONG MA/</u>
<u>YICHANG LIU</u>	<u>/YICHANG LIU/</u>
<u>JUNXI LI</u>	<u>/JUNXI LI/</u>